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Multicore SDK (MCSDK) Release Notes



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Chapter 1 Overview

These are the release notes for the NXP Multicore Software Development Kit (MCSDK) version 2.7.0. This software package contains components for efficient work with multicore devices as well as for the multiprocessor communication.

Chapter 2 What is new

- eRPC: Improved the test_callbacks logic to be more understandable and to allow requested callback execution on the server side.
- eRPC: TransportArbitrator::prepareClientReceive modified to avoid incorrect return value type.
- eRPC: The ClientManager and the ArbitratedClientManager updated to avoid performing client requests when the previous serialization phase fails.
- erpcgen: Generate the shim code for destroy of statically allocated services.
- RPMsg-Lite: MISRA C-2012 violations fixed, incl. data types consolidation.
- RPMsg-Lite: Code formatted.
- MCMgr: Code adjustments to address MISRA C-2012 Rules.
- Supported evaluation boards (multicore examples):
 - LPCXpresso54114
 - LPCXpresso55S69
 - FRDM-K32L3A6
- Supported evaluation boards (multiprocessor examples):
 - FRDM-K22F
 - FRDM-K28FA
 - FRDM-K64F
 - FRDM-K66F
 - FRDM-K82F
 - FRDM-KL27Z
 - FRDM-KL43Z

Chapter 3 Development tools

The Multicore SDK (MCSDK) version 2.7.0 was compiled and tested with these development tools:

- IAR Embedded Workbench for Arm® version 8.40.2
- MDK-ARM Microcontroller Development Kit ${\rm (Keil)}^{\rm @}$ version 5.29
- Makefiles support with GCC revision 8-2019q3-update from Arm Embedded
- MCUXpresso IDE v11.1.0

Chapter 4 Release contents

This table describes the release contents. Not all MCUXpresso SDK packages contain the whole set of these components.

Table 1. Release contents

Deliverable	Location
Multicore SDK location within the MCUXpresso SDK folder structure	<mcuxpressosdk_install_dir>/middleware/multicore/</mcuxpressosdk_install_dir>
Documentation	<mcuxpressosdk_install_dir>/docs/multicore/</mcuxpressosdk_install_dir>
Embedded Remote Procedure Call component	<mcsdk_dir>/erpc/</mcsdk_dir>
Multicore Manager component	<mcsdk_dir>/mcmgr/</mcsdk_dir>
RPMsg-Lite	<mcsdk_dir>/rpmsg_lite/</mcsdk_dir>
Multicore demo applications	<mcuxpressosdk_install_dir>/boards/<board_name>/ multicore_examples/</board_name></mcuxpressosdk_install_dir>
Multiprocessor demo applications	<pre><mcuxpressosdk_install_dir>/boards/<board_name>/ multiprocessor_examples/</board_name></mcuxpressosdk_install_dir></pre>

Chapter 5 Multicore SDK release overview

Together, the Multicore SDK (MCSDK) and the MCUXpresso SDK (SDK) form a framework for the development of software for NXP multicore devices. The MCSDK release consists of the following elementary software components for multicore:

- Embedded Remote Procedure Call (eRPC)
- Multicore Manager (MCMGR) included just in SDK for multicore devices
- · Remote Processor Messaging Lite (RPMsg-Lite) included just in SDK for multicore devices

The MCSDK is also accompanied with documentation and several multicore and multiprocessor demo applications.

Chapter 6 Demo applications

The multicore demo applications demonstrate the usage of the MCSDK software components on supported multicore development boards. The following multicore demo applications are located together with other MCUXpresso SDK examples in the MCUXpressoSDK_install_dir / boards / cboard_name > / multicore_examples... subdirectories.

- · erpc_matrix_multiply_mu
- · erpc_matrix_multiply_mu_rtos
- erpc_matrix_multiply_rpmsg
- · erpc_matrix_multiply_rpmsg_rtos
- erpc_two_way_rpc_rpmsg_rtos
- freertos_message_buffers
- · hello_world
- · low_power
- · multicore_manager
- · rpmsg_lite_pingpong
- rpmsg_lite_pingpong_rtos
- rpmsg_lite_pingpong_tzm

The eRPC multicore component can be leveraged for inter-processor communication and remote procedure calls between SoCs / development boards. The following multiprocessor demo applications are located together with other MCUXpresso SDK examples in the MCUXpressoSDK install dir>/boards/<base>board_name>/multiprocessor_examples... subdirectories.

- erpc_client_matrix_multiply_spi
- · erpc_server_matrix_multiply_spi
- · erpc_client_matrix_multiply_uart
- · erpc_server_matrix_multiply_uart
- erpc_server_dac_adc
- · erpc_remote_control

Chapter 7 Revision history

This table summarizes revisions to this document.

Table 2. Revision history

Revision number	Date	Substantive changes
0	09/2015	Initial release
1	03/2016	Updated for the KSDK 2.0.0 and the MCSDK 1.1.0
2	08/2016	Updated for the MCSDK 2.0.0 and the LPCXpresso54114 support
3	09/2016	Updated for the MCSDK 2.1.0
4	03/2017	Updated for the MCSDK 2.2.0
5	06/2017	Updated for the MCSDK 2.2.1 and the LPCXpresso54102 support
7	11/2017	Updated for the MCSDK 2.3.0 and MCUXpresso SDK 2.3.0 release
8	05/2018	Updated for the MCSDK 2.4.0 and MCUXpresso SDK 2.4.0 release
9	12/2018	Updated for the MCSDK 2.5.0 and MCUXpresso SDK 2.5.0 release
10	06/2019	Updated for the MCSDK 2.6.0 and MCUXpresso SDK 2.6.0 release
11	12/2019	Updated for the MCSDK 2.7.0 and MCUXpresso SDK 2.7.0 release

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